DISCRETE SEMICONDUCTORS

DATA SHEET

J174; J175; J176; J177

P-channel silicon field-effect transistors

Product specification
File under Discrete Semiconductors, SC07

April 1995





P-channel silicon field-effect transistors

J174; J175; J176; J177

DESCRIPTION

Silicon symmetrical p-channel junction FETs in a plastic TO-92 envelope and intended for application with analog switches, choppers, commutators etc.

A special feature is the interchangeability of the drain and source connections.

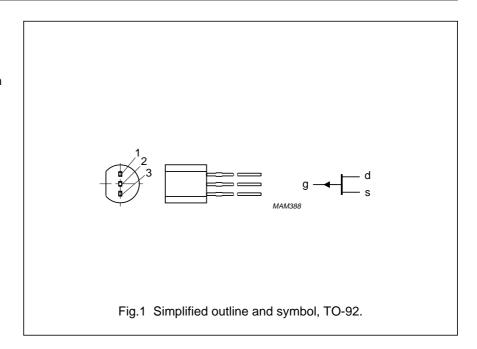
PINNING

1 = source

2 = gate

3 = drain

Note: Drain and source are interchangeable.



QUICK REFERENCE DATA

Drain-source voltage	± V _{DS}	max.		30			V
Gate-source voltage	V_{GSO}	max.		30			V
Gate current	$-I_{G}$	max.		50			mA
Total power dissipation							
up to $T_{amb} = 50 ^{\circ}C$	P_{tot}	max.		400			mW
			J174	J175	J176	J177	
Drain current $-V_{DS} = 15 \text{ V}; V_{GS} = 0$	-I _{DSS}	min. max.	20 135	7 70	2 35	1.5 20	mA mA
Drain-source ON-resistance							
$-V_{DS} = 0.1 \text{ V}; V_{GS} = 0$	$R_{DS on}$	max.	85	125	250	300	Ω

April 1995 2

Philips Semiconductors Product specification

J174; J175; P-channel silicon field-effect transistors J176; J177 **RATINGS** Limiting values in accordance with the Absolute Maximum System (IEC 134) Drain-source voltage $\pm V_{DS}$ 30 ٧ max. Gate-source voltage V_{GSO} 30 ٧ max. V Gate-drain voltage V_{GDO} 30 max. Gate current (DC) 50 $-I_G$ max. mA Total power dissipation up to $T_{amb} = 50 \, ^{\circ}C$ P_{tot} 400 mW max. ٥С Storage temperature range T_{stg} -65 to +150 ٥С Junction temperature T_i 150 max. THERMAL RESISTANCE 250 K/W From junction to ambient in free air R_{th j-a} STATIC CHARACTERISTICS J175 J176 J177 T_i = 25 °C unless otherwise specified J174 Gate cut-off current $V_{GS} = 20 \text{ V}; V_{DS} = 0$ 1 1 1 1 nA max. I_{GSS} Drain cut-off current $-V_{DS} = 15 \text{ V}; V_{GS} = 10 \text{ V}$ $-I_{DSX}$ max. 1 1 1 nA Drain current 20 7 2 1.5 mA min. $-V_{DS} = 15 \text{ V}; V_{GS} = 10 \text{ V}$ $-I_{\text{DSS}}$ 70 max. 135 35 20 mA Gate-source breakdown voltage $I_G=1~\mu A;~V_{DS}=0$ $V_{(BR)GSS}$ min. 30 30 30 30 V Gate-source cut-off voltage min. 5 3 1 0.8 V $-I_D = 10 \text{ nA}; V_{DS} = -15 \text{ V}$ $V_{GS off}$ 6 2.25 V max. 10 4 Drain-source ON-resistance

R_{DSon}

85

max.

125

250

300 Ω

April 1995 3

 $-V_{DS} = 0.1 \text{ V}; V_{GS} = 0$

Philips Semiconductors Product specification

P-channel silicon field-effect transistors

J174; J175; J176; J177

DYNAMIC CHARACTERISTICS

T_i = 25 °C unless otherwise specified

Input capacitance, f = 1 MHz

 $V_{GS} = 10 \text{ V}; V_{DS} = 0 \text{ V}$

 $V_{GS} = V_{DS} = 0$

Feedback capacitance, f = 1 MHz

 $V_{GS} = 10 \text{ V}; V_{DS} = 0 \text{ V}$

Switching times (see Fig.2 + 3)

Delay time

Rise time

Turn-on time

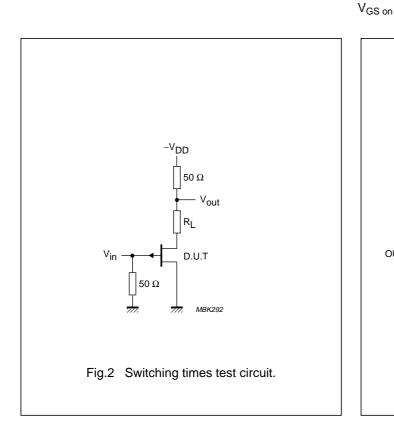
Storage time

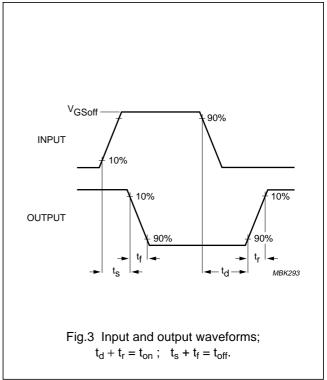
Fall time

Turn-off time

Test conditions:

C _{is}	typ.		8			pF
C_{is}	typ.		30			pF
C _{rs}	typ.	ı	4		ı	рF
		J174	J175	J176	J177	_
t_d	typ.	2	5	15	20	ns
t_r	typ.	5	10	20	25	ns
t_{on}	typ.	7	15	35	45	ns
t_s	typ.	5	10	15	20	ns
t_{f}	typ.	10	20	20	25	ns
t_{off}	typ.	15	30	35	45	ns
$-V_{DD}$		10	6	6	6	V
$V_{GS \ off}$		12	8	6	3	V
R_{L}		560	1200	2000	2900	Ω
$V_{GS\ on}$		0	0	0	0	V





April 1995 4 Philips Semiconductors Product specification

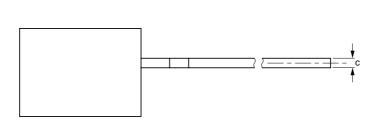
P-channel silicon field-effect transistors

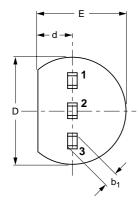
J174; J175; J176; J177

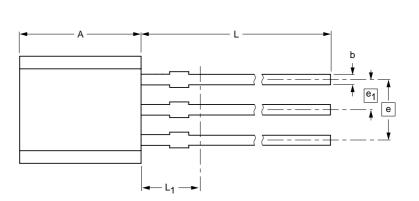
PACKAGE OUTLINE

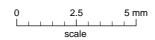
Plastic single-ended leaded (through hole) package; 3 leads

SOT54









DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾
mm	5.2 5.0	0.48 0.40	0.66 0.56	0.45 0.40	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT54		TO-92	SC-43			97-02-28	

April 1995 5

Philips Semiconductors Product specification

P-channel silicon field-effect transistors

J174; J175; J176; J177

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Short-form specification	The data in this specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.
1	

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

April 1995 6